# UNITED STATES SECURITIES AND EXCHANGE COMMISSION

Washington, DC 20549

FORM 6-K
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REPORT OF FOREIGN PRIVATE ISSUER PURSUANT TO RULE 13a-16 OR 15d-16 UNDER THE SECURITIES EXCHANGE ACT OF 1934

For the month of March, 2019

Commission File Number 001-37928

## ChipMOS TECHNOLOGIES INC.

(Translation of Registrant's Name Into English)

No. 1, R&D Rd. 1, Hsinchu Science Park Hsinchu, Taiwan Republic of China (Address of Principal Executive Offices)

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(Indicate by check mark whether the registrant files or will file annual reports under cover of Form 20-F or Form 40-F.)						
Fo	orm 20-F ⊠ F	Form 40-F 🗆				
Indicate by check mark if the registrant is submitting the For	m 6-K in paper as pe	ermitted by Regulation S-T Rule 101(b)(1): $\Box$				
Indicate by check mark if the registrant is submitting the For	m 6-K in paper as pe	ermitted by Regulation S-T Rule 101(b)(7):				

#### **SIGNATURES**

Pursuant to the requirements of the Securities Exchange Act of 1934, the registrant has duly caused this report to be signed on its behalf by the undersigned, thereunto duly authorized.

Dated: March 7, 2019

### ChipMOS TECHNOLOGIES INC.

(Registrant)

/S/ S. J. Cheng By:

Name: S. J. Cheng
Title: Chairman & President

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#### ChipMOS REPORTS FEBRUARY 2019 REVENUE

**Hsinchu, Taiwan, March 7, 2019** - ChipMOS TECHNOLOGIES INC. ("ChipMOS" or the "Company") (Taiwan Stock Exchange: 8150 and NASDAQ: IMOS), an industry leading provider of outsourced semiconductor assembly and test services ("OSAT"), today reported its unaudited consolidated revenue for the month of February 2019. All U.S. dollar figures cited in this press release are based on the exchange rate of NT\$30.83 to US\$1.00 as of February 28, 2019.

Revenue for the month of February 2019 was NT\$1,328.5 million or US\$43.1 million, a decrease of 14.3% from the month of January 2019 and an increase of 9.8% from the same period in 2018. The Company noted that growth from higher TDDI demand and favorable pricing was offset by softness impacting the broader industry in the memory business and a lower number of working days around the New Year Holiday. Based on historical trends, the Company expects the first quarter overall representing the low point for the year due to the above noted factors.

#### **Consolidated Monthly Revenues (Unaudited)**

	February 2019	January 2019	February 2018	MoM Change	YoY Change
Revenues		· <u> </u>	<u></u>		
(NT\$ million)	1,328.5	1,549.9	1,210.4	-14.3%	9.8%
Revenues					
(US\$ million)	43.1	50.3	39.3	-14.3%	9.8%

#### **About ChipMOS TECHNOLOGIES INC.:**

ChipMOS TECHNOLOGIES INC. (Taiwan Stock Exchange: 8150 and NASDAQ: IMOS) (https://www.chipmos.com) is an industry leading provider of outsourced semiconductor assembly and test services. With advanced facilities in Hsinchu Science Park, Hsinchu Industrial Park and Southern Taiwan Science Park in Taiwan, ChipMOS provide assembly and test services to a broad range of customers, including leading fabless semiconductor companies, integrated device manufacturers and independent semiconductor foundries.

#### **Forward-Looking Statements**

This press release may contain certain forward-looking statements. These forward-looking statements may be identified by words such as 'believes,' 'expects,' 'anticipates,' 'projects,' 'intends,' 'should,' 'seeks,' 'estimates,' 'future' or similar expressions or by discussion of, among other things, strategy, goals, plans or intentions. These statements may include financial projections and estimates and their underlying assumptions, statements regarding plans, objectives and expectations with respect to future operations, products and services, and statements regarding future performance. Actual results may differ materially in the future from those reflected in forward-looking statements contained in this document, due to various factors. Further information regarding these risks, uncertainties and other factors are included in the Company's most recent Annual Report on Form 20-F filed with the U.S. Securities and Exchange commission (the "SEC") and in the Company's other filings with the SEC.